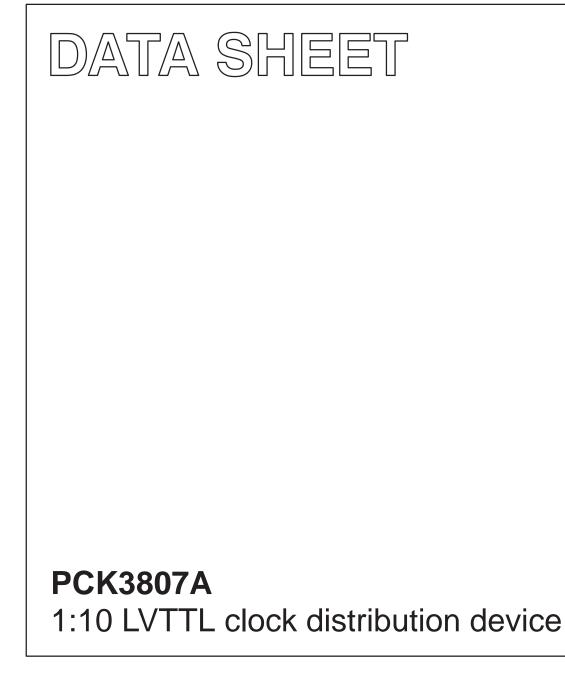
INTEGRATED CIRCUITS



Product data sheet Supersedes data of 2003 Jun 27 2004 Aug 27



DESCRIPTION

This low skew clock driver offers 1:10 fan-out. The large fan out from a single input reduces loading on the preceding driver and provides an efficient clock distribution network. The PCK3807A offers low capacitance inputs with hysteresis for improved noise margins. Multiple power and grounds reduce noise. Typical applications are clock and signal distribution.

The PCK3807A operates from a single 2.5 V or 3.3 V supply voltage and over the full industrial temperature range of -40 °C to +85 °C.

FEATURES

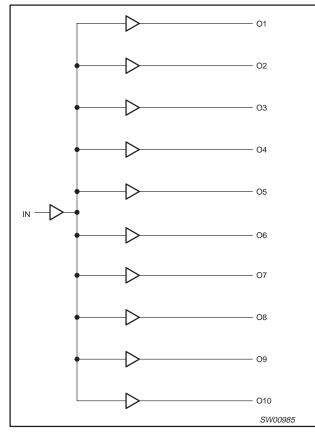
- Low output skew < 120 ps (max)
- Very low duty cycle distortion < 200 ps (max) for V_{CC} = 2.5 V

ORDERING INFORMATION

- High speed: propagation delay < 3.5 ns (max)
- Very low CMOS power levels
- TTL compatible inputs and outputs
- 1:10 fanout
- Maximum output rise and fall times < 1.5 ns
- Low input capacitance: 2.5 pF typical
- $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$
- Overvoltage tolerance on inputs
- Available in SSOP, TSSOP, SO and QSOP packages
- >150 MHz operation

PACKAGES TEMPERATURE RANGE		ORDER CODE	DRAWING NUMBER			
20-Pin Plastic SO	–40 °C to +85 °C	PCK3807AD	SOT163-1			
20-Pin Plastic SSOP	–40 °C to +85 °C	PCK3807ADB	SOT339-1			
20-Pin Plastic TSSOP	–40 °C to +85 °C	PCK3807APW	SOT360-1			
20-Pin Plastic SSOP (QSOP)	–40 °C to +85 °C	PCK3807ADS	SOT724-1			

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION

	20 V _{CC}
	19 O10
	18 O9
	17 GND
	16 O8
	15 V _{CC}
	14 07
	13 GND
	12 O6
	11 O5
SW00986	I
	SW00986

PIN DESCRIPTION

Symbol	Pin	Description
IN	1	Clock input
O1 to O10	3, 5, 7, 9, 11, 12, 14, 16, 18, 19	Clock outputs
GND	2, 10, 13, 17	Ground
V _{CC}	20	Supply voltage

PCK3807A

ABSOLUTE MAXIMUM RATINGS¹

SYMBOL	DESCRIPTION	MIN	MAX	UNIT
V _{TERM} ²	Terminal voltage with respect to GND	-0.5	+4.6	V
V _{TERM} ³	Terminal voltage with respect to GND	-0.5	+7	V
V _{TERM} ⁴	Terminal voltage with respect to GND	-0.5	V _{CC} +0.5	V
T _{stg}	Storage temperature	-65	+150	°C
Io	DC output current	-60	+60	mA

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. \dot{V}_{CC} terminals.

3. Input terminal.

4. Outputs terminals.

CAPACITANCE

 $T_{amb} = +25 \ ^{\circ}C, f = 1.0 \ MHz$

SYMBOL	PARAMETER	CONDITIONS	ТҮР	MAX	UNIT
C _i	Input capacitance	$V_{IN} = 0 V$	2.5	4	pF
Co	Output capacitance	V _{OUT} = 0 V	5.5	6	pF

NOTE:

1. This parameter is measured at characterization but not tested.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			
STMBOL	PARAIVIETER	MIN	МАХ		
V _{CC}	DC supply voltage	2.3	3.6	V	
f _{IN}	Input signal frequency	0	150	MHz	
T _{amb}	Operating free-air temperature range	-40	+85	°C	
CL	Output capacitance load	-	50	pF	

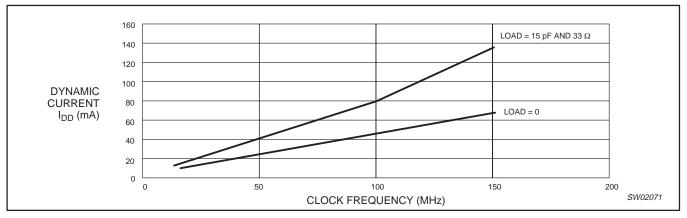


Figure 1. Dynamic current vs. clock frequency, V_{CC} = 3.3 V

PCK3807A

POWER SUPPLY CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNIT
ΔI_{CC}	Quiescent power supply current, TTL inputs HIGH	$V_{CC} = max; V_{IN} = V_{CI}$	V_{CC} = max; V_{IN} = V_{CC} – 0.6 V		3	30	μΑ
I _{CCD}	Dynamic power supply current	V _{CC} = 2.7 V Input toggling	Outputs open	-	0.31	0.45	mA/MHz
		50% duty cycle $V_{IN} = V_{CC}$ or GND	15 pF and 33 Ω load	-	1.0	-	1
		V _{CC} = 3.6 V	Outputs open	-	0.5	0.75	1
			15 pF and 33 Ω load	-	1.5	-	1
I _C	Total power supply current Dynamic power supply current	V _{CC} = 2.7 V Input toggling 50% duty cycle	$ \begin{array}{l} V_{IN} = V_{CC} \\ V_{IN} = GND \\ f_i = 50 \mbox{ MHz} \end{array} $	-	15.5	22.8	mA
		Outputs open	$ \begin{array}{l} V_{IN} = V_{CC} \\ V_{IN} = GND \\ f_i = 150 \mbox{ MHz} \end{array} $	-	50	75	
		V _{CC} = 3.6 V	f _i = 50 MHz	-	25	37	1
			f _i = 150 MHz	-	75	115	1

NOTES:

1. For conditions shown as Max or Min, use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at $V_{CC} = 3.3 V$, +25°C ambient. 3. Per TTL driven input ($V_{IN} = V_{CC} - 0.6 V$). 4. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.

5. Values for these conditions are examples of the lc formula. These limits are guaranteed but not tested.

5. Values for these conditions are examples of the ic formula. These limits are 6. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$ $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (fi)$ $I_{CC} = Quiescent Current (I_{CCL}, I_{CCH} and I_{CCZ})$ $\Delta I_{CC} = Power Supply Current for a TTL High Input (V_{IN} = V_{CC} - 0.6 V)$ DH = Duty Cycle for TTL Inputs High $N_T = Number of TTL Inputs at D_H$ $I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)$ $<math>f_r = Input Frequency$

 $f_i = Input Frequency$

All currents are in milliamps and all frequencies are in MHz

PCK3807A

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

 T_{amb} = –40 °C to +85 °C, V_{CC} = 3.3 V \pm 0.3 V, unless otherwise specified

SYMBOL	PARAMETER	TEST CONDITIONS ¹		MIN	TYP	MAX	UNIT
VIH	HIGH-level input voltage (Input pins)	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2	-	5.5	V
	HIGH-level input voltage (I/O pins)	00		1.7	-	3.6	1
V _{IL}	LOW-level input voltage (Input pins)	V _{CC} = 3.0 V to 3.6 V		-0.5	-	0.8	V
	LOW-level input voltage (I/O pins)	V_{CC} = 2.3 V to 2.7 V	00		-	0.7	1
IIH	HIGH-level input current (Input pins)	V _{CC} = Max	V _I = 5.5 V	-	-	± 1	μA
	HIGH-level input current (I/O pins)	1	$V_I = V_{CC}$	-	-	± 1	1
IIL	LOW-level input current (Input pins)	V _{CC} = Max	V _I = GND	-	-	± 1	μA
	LOW-level input current (I/O pins)		V _I = GND	-	-	± 1	1
V _{IK}	Clamp diode voltage	V _{CC} = Min; I _{IN} = -18 m	nA	-	-0.7	-1.0	V
I _{ODH}	HIGH-level input current	V _{CC} = 3.3 V; V _{IN} = V _{IH}	$V_{CC} = 3.3 \text{ V}; \text{ V}_{IN} = \text{V}_{IH} \text{ or } \text{V}_{IL}; \text{ Vo} = 1.5 \text{ V}^3$		-120	-150	mA
I _{ODL}	LOW-level input current	V _{CC} = 3.3 V; V _{IN} = V _{IH}	V_{CC} = 3.3 V; V_{IN} = V_{IH} or V_{IL} ; Vo =1.5 V ³		150	200	mA
V _{OH}	HIGH-level output voltage	$V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$	I _{OH} = -0.1 mA	V _{CC} - 0.2	-	-	V
		V _{CC} = 2.3 V	I _{OH} = -8 mA	1.9	-	-	1
		V _{CC} = 3.0 V	I _{OH} = -8 mA	2.4 ⁶	3	-	1
V _{OL}	LOW-level output voltage	$V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$	I _{OL} = 0.1 mA	-	-	0.2	V
		V _{CC} = 2.3 V	I _{OL} = 8 mA	-	-	0.3	1
		V _{CC} = 3.0 V	I _{OL} = 16 mA	-	0.2	0.4	1
		V _{CC} = 3.0 V	I _{OL} = 24 mA	-	0.3	0.5	1
I _{OFF}	Input power off leakage	V _{CC} = 0 V; V _{IN} = 4.5 V	,	-	-	± 1	μA
I _{OS}	Short circuit current ⁵	$V_{CC} = Max; V_O = GND^4$		0	-155	-240	mA
V _{hys}	Input hysteresis	-		-	150	-	mV
I _{CCL} I _{CCH}	Quiescent power supply current	V _{CC} = Max V _{IN} = GND or V _{CC}		-	0.1	10	μΑ

NOTES:

For conditions shown as Max or Min, use appropriate value specified under Electrical Characteristics for the applicable device type.
Typical values are at V_{CC} = 3.3 V, +25 °C ambient.
Duration of the test should not exceed one second.
Not more than one output shorted at one time. Duration of the test should not exceed one second.

5. This parameter is guaranteed but not tested. 6. $V_{OH} = V_{CC} - 0.6$ V at rated current.

PCK3807A

SWITCHING CHARACTERISTICS OVER OPERATING RANGE - INDUSTRIAL^{3,4}

 T_{amb} = –40 °C to +85 °C, V_{CC} = 3.3 V \pm 0.3 V, unless otherwise specified

SYMBOL	DADAMETED	CONDITIONS ¹	2.5 V	± 0.2 V	3.3 V ± 0.3 V		
STMBOL	PARAMETER	CONDITIONS.	MIN ²	MAX	MIN ²	MAX	
t _{PLH} t _{PHL}	Propagation delay	50 Ω to V _{CC} /2; C _L = 10 pF (See Figure 2)	1.5	2.7	1.3	2.5	ns
t _R	Output rise time	or	-	1.0	-	1.0	ns
t _F	Output fall time	-	-	1.0	1	1.0	ns
t _{SK(o)}	Output skew: skew between outputs of same package (same transition)	ew between outputs of same 50Ω AC termination;				0.12	ns
t _{SK(p)}	Pulse skew: skew between opposite transitions of same output ($ t_{PHL}-t_{PLH} $)	$f \le 150 \text{ MHz}$; Outputs connected in groups of two	-	0.3	-	0.45	ns
t _{SK(t)}	Package skew: skew between outputs of different packages at same power supply voltage, temperature, package type and speed grade		-	0.6	-	0.6	ns
t _{PLH} t _{PHL}	Propagation delay	50 Ω to V _{CC} /2; C _L = 22 pF (See Figure 2)	1.5	3.5	1.5	3	ns
t _R	Output rise time	or	-	1.0	-	1.0	ns
t _F	Output fall time		—	1.0	-	1.0	ns
t _{SK(o)}	Output skew: skew between outputs of same package (same transition)	50 Ω AC termination; C _L = 22 pF (See Figure 3);	-	0.12	-	0.12	ns
t _{SK(p)}	Pulse skew: skew between opposite transitions of same output ($ t_{PHL}-t_{PLH} $)	-	0.3	-	0.45	ns	
t _{SK(t)}	Package skew: skew between outputs of different packages at same power supply voltage, temperature, package type and speed grade		-	0.6	-	0.6	ns
t _{PLH} t _{PHL}	Propagation delay	$C_L = 30 \text{ pF}; f \le 67 \text{ MHz}$ (See Figure 4)	1.5	4.0	1.5	4	ns
t _R	Output rise time		-	1.0	-	1.0	ns
t _F	Output fall time		-	1.0	-	1.0	ns
t _{SK(o)}	Output skew: skew between outputs of same package (same transition)		-	0.35	-	0.35	ns
t _{SK(p)}	Pulse skew: skew between opposite transitions of same output ($ t_{PHL}-t_{PLH} $)		-	0.35	-	0.35	ns
t _{SK(t)}	Package skew: skew between outputs of different packages at same power supply voltage, temperature, package type and speed grade		-	1.0	-	0.75	ns
t _{jitter}	RMS jitter		-	1.0	-	1.0	ps
f _{MAX}	Maximum output frequency	Functional to 400 MHz	-	400	-	400	MHz
t _{PLH} t _{PHL}	Propagation delay	$C_L = 50 \text{ pF}; f \le 40 \text{ MHz}$ (See Figure 5)	1.5	4.5	1.5	4.0	ns
t _R	Output rise time		-	1.5	-	1.5	ns
t _F	Output fall time		-	1.5	-	1.5	ns
t _{SK(o)}	Output skew: skew between outputs of same package (same transition)		-	0.35	-	0.35	ns
t _{SK(P)}	Pulse skew: skew between opposite transitions of same output ($ t_{PHL}-t_{PLH} $)		-	0.75	-	0.75	ns
t _{SK(T)}	Package skew: skew between outputs of different packages at same power supply voltage, temperature, package type and speed grade		-	1	-	0.75	ns

NOTES:

1. See test circuits and waveforms.

See lest circuits and waveforms.
Minimum limits are guaranteed but not tested on Propagation Delays.
t_{PLH}, t_{PHL}, t_{SK(t)} are production tested. All other parameters guaranteed but not production tested.
Propagation delay range indicated by Min and Max limit is due to V_{CC}, operating temperature and process parameters. These propagation delay limits do not imply skew.

TEST CIRCUITS

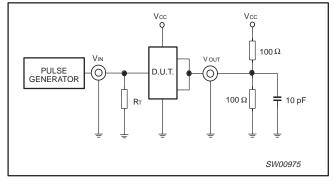
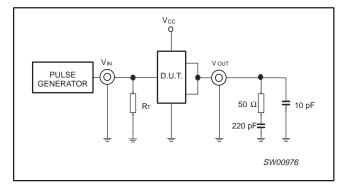
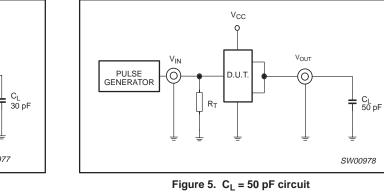


Figure 2. $Z_O = 50 \ \Omega$ TO V_{CC}/2, C_L = 10 pF



The capacitor value for ac termination is determined by the operating frequency. For very low frequencies a higher capacitor value should be selected.

Figure 3. $Z_0 = 50 \Omega$ AC termination, $C_L = 10 \text{ pF}$



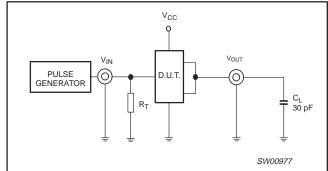


Figure 4. $C_L = 30 \text{ pF circuit}$

PCK3807A

TIMING DIAGRAMS

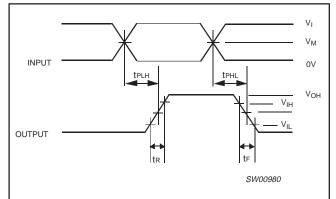


Figure 6. Package delay (see Table 1)

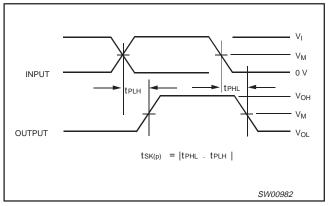


Figure 8. Pulse skew – t_{SK(p)} (see Table 1)

Table 1. Reference levels

Reference level	VI	V _M
For V_{CC} = 3.3 \pm 0.3 V	3.0 V	1.5 V
For V_{CC} = 2.5 \pm 0.2 V	V _{CC}	V _{CC} /2

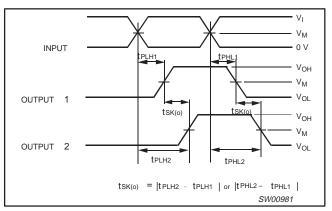


Figure 7. Output skew – $t_{SK(O)}$ (see Table 1)

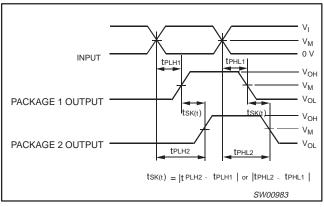
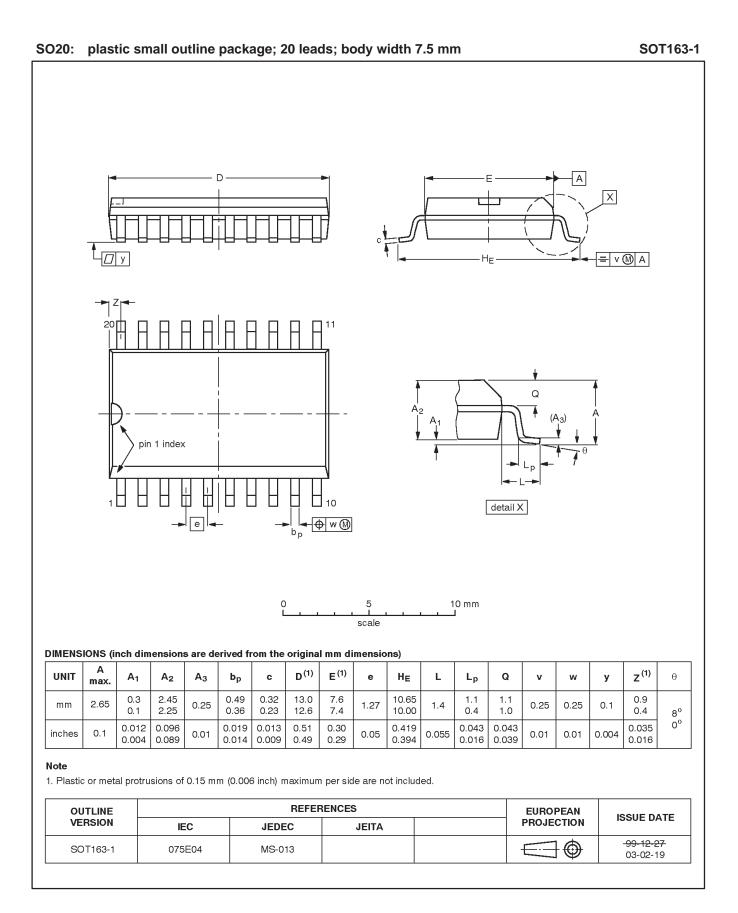
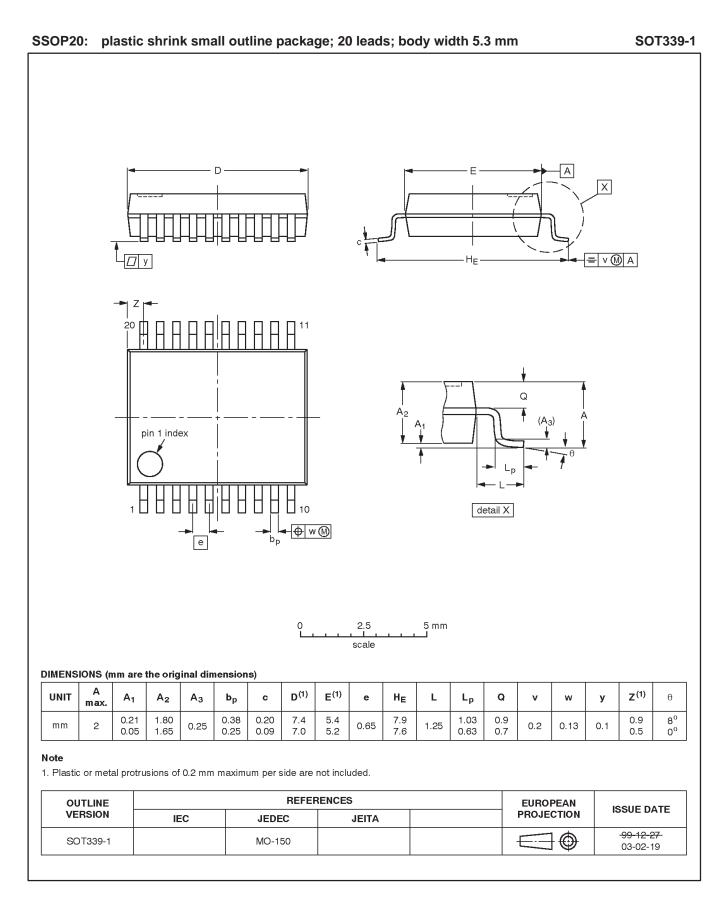
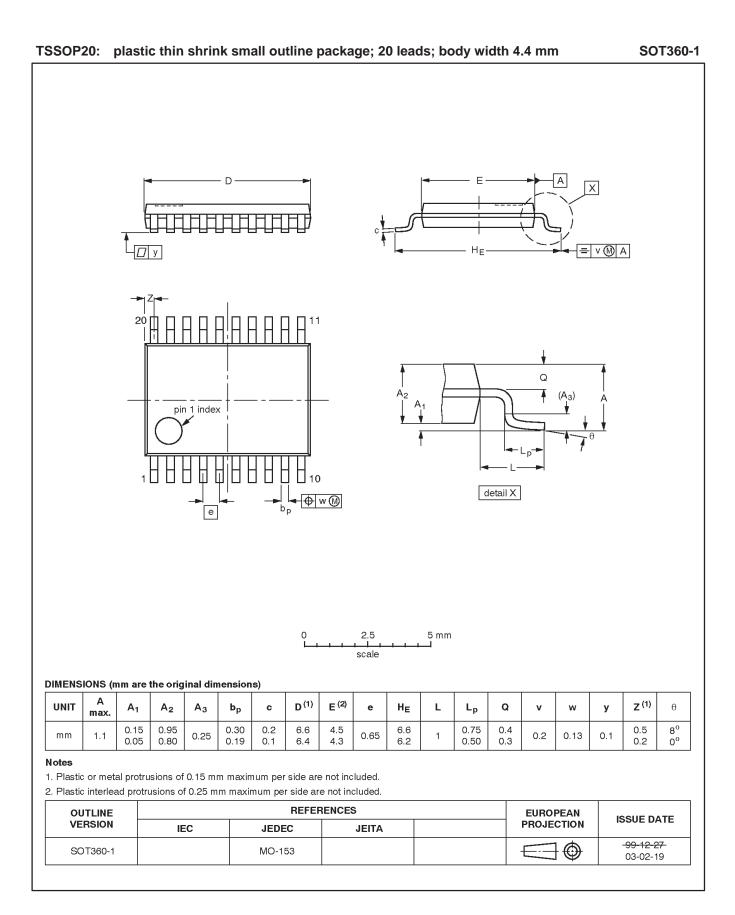


Figure 9. Package skew – t_{SK(y)} (see Table 1)







2004 Aug 27

OUTLINE

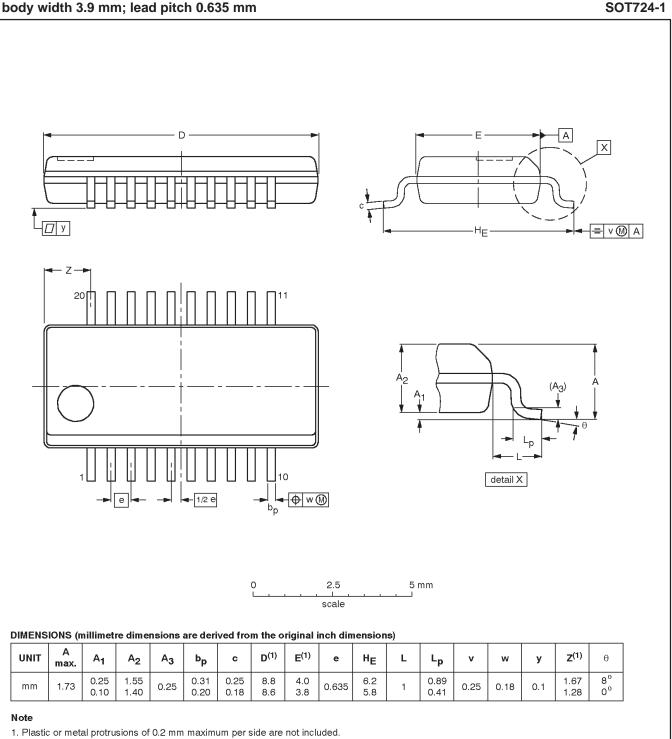
VERSION

SOT724-1

IEC

1:10 LVTTL clock distribution device

SSOP20: plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm



PCK3807A

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PROJECTION

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ISSUE DATE

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03-02-18

REFERENCES

JEDEC

MO-137

PCK3807A

1:10 LVTTL clock distribution device

REVISION HISTORY

Rev	Date	Description			
_2	20040827	Product data sheet (9397 750 14007). Supersedes data of 2003 Jun 27 (9397 750 11683).			
		Modifications:			
		• Recommended Operating Conditions table on page 3: change V _{CC} Min. limit from 2.5 V to 2.3 V.			
_1	20030627	Product data (9397 750 11683); ECN 853-2431 30019 dated 18 June 2003. Initial version			

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
111	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Date of release: 08-04

9397 750 14007

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Document order number:



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